

57-21/B7C-AS1T2M/BF

Features

- Fluorescence Type
- High Luminous Intensity
- High Efficiency
- Pb-free
- The product itself will remain within RoHS compliant version.



Descriptions

• The 57-21series is available in soft orange, green, blue and yellow. Due to the package design, the LED has wide viewing angle and optimized light coupling by inter reflector. This feature makes ideal for light pipe application. The low current requirement makes this device ideal for portable equipment or any other application where power is at a premium.

Applications

- OA equipment
- Backlighting of full color LCD
- Automotive equipment
- Replacement of conventional light bulbs and Fluorescent Lamps

Device Selection Guide

Chip	F. W. I.C.L.	Resin Color	
Material	Emitted Color		
InGaN	Blue	Water Clear	

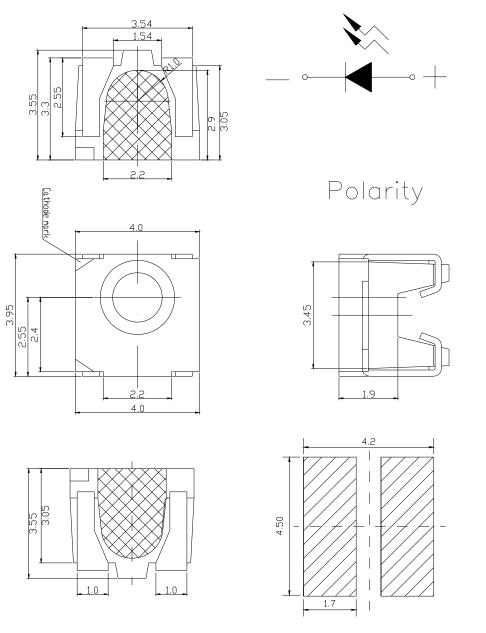
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Technical Data Sheet

Side View LED

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Package Outline Dimensions



Recommended soldering pad design

Note: Tolerances unless mentioned are ± 0.1 mm, unit = mm.

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Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V_R	5	V	
Forward Current	I_{F}	30	mA	
Peak Forward Current (Duty 1/10 @1KHz)	I_{FP}	100	mA	
Power Dissipation	Pd	110	mW	
Electrostatic Discharge(HBM)	ESD	1000	V	
Operating Temperature	Topr	-40 ~ +85	$^{\circ}$ C	
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\!\mathbb{C}$	
Soldering Temperature	Tsol	Reflow Soldering : 260°C for 10 sec. Hand Soldering : 350°C for 3 sec.		

Electro-Optical Characteristics (Ta=25°C)

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Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	180		450	mcd	
Viewing Angle	201/2		120		deg	
Peak Wavelength	λр		468		nm	
Dominant Wavelength	λd	464.5		476.5	nm	$I_F=20\text{mA}$
Spectrum Radiation Bandwidth	Δλ		25		nm	
Forward Voltage	V_{F}	2.75		3.95	V	
Reverse Current	I_R			50	μΑ	V _R =5V

Notes:

1. Tolerance of Luminous Intensity: ±11%

2. Tolerance of Dominant Wavelength: ±1nm

3. Tolerance of Forward Voltage: ± 0.05 V

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Bin Range of Dominant Wavelength

Groups	Bin	Min	Max	Unit	Condition	
A	A9	464.5	467.5			
	A10	467.5	470.5		I 20 A	
	A11	470.5	473.5	nm	$I_F=20\text{mA}$	
	A12	473.5	476.5			

Bin Range of Luminous Intensity

Bin Code	Min.	Max.	Unit	Conduction		
S1	180	225				
S2	225	285	mod	I _F =20mA		
T1	285	360	mcd			
T2	360	450				

Bin Range of Forward Voltage

Groups	Bin	Min	Max	Unit	Condition	
М	5	2.75	3.05			
	6	3.05	3.35	14	I -20 A	
	7	3.35	3.65	volt	$I_F=20\text{mA}$	
	8	3.65	3.95			

Notes:

1. Tolerance of Luminous Intensity: ±11%

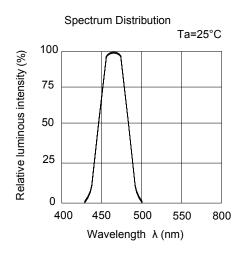
2. Tolerance of Dominant Wavelength: ± 1 nm

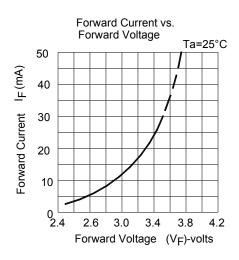
3. Tolerance of Forward Voltage: $\pm 0.1 V$

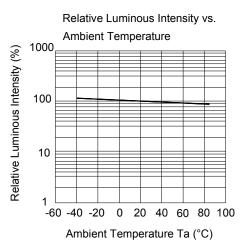
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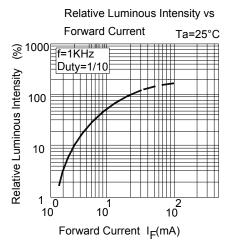
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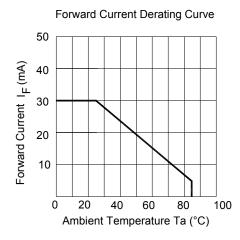
Typical Electro-Optical Characteristics Curves

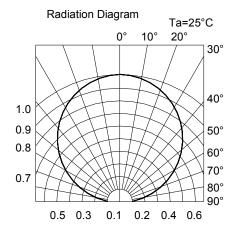












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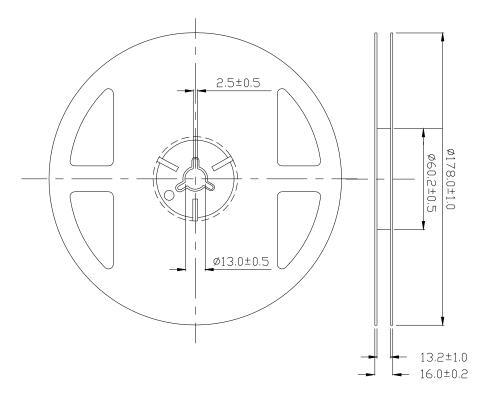
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Label Explanation

CAT: Luminous Intensity Rank HUE: Dom. Wavelength Rank REF: Forward Voltage Rank



Reel Dimensions



Note: Tolerance unless mentioned is ± 0.1 mm, unit = mm.

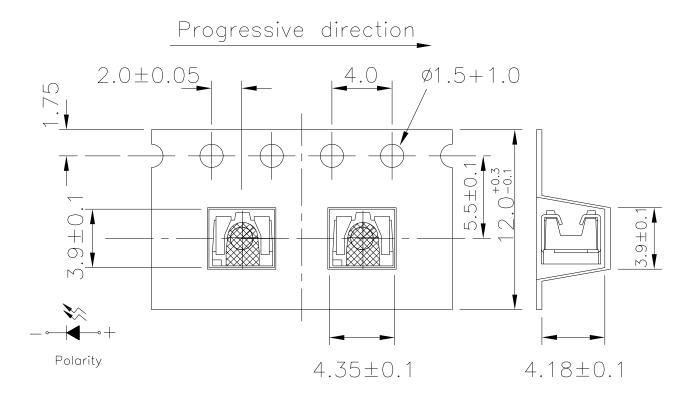
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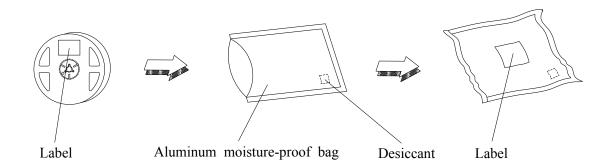
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Carrier Tape Dimensions: Loaded Quantity 500 pcs. Per Reel



Note: Tolerance unless mentioned is ± 0.1 mm, unit = mm.

Moisture Resistant Packaging



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Reliability Test Items and Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 pcs.	0/1
2	Temperature Cycle	H:+100°C 15min ∫5 min L:-40°C 15min	300 Cycles	22 pcs.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 pcs.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 pcs.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 pcs.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 pcs.	0/1
7	High Temperature / High Humidity	85°C/85%RH	1000 Hrs.	22 pcs.	0/1

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Precautions for Use

1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

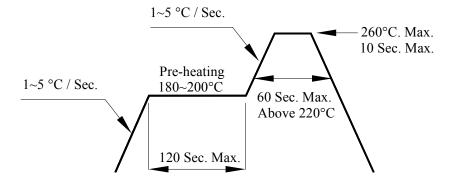
2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 168 hours under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5°C for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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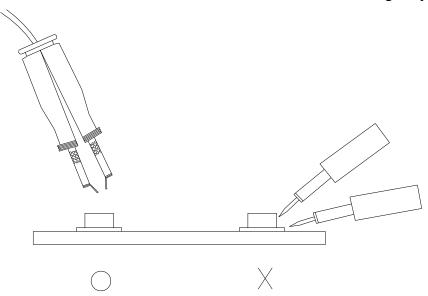
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4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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